

SM1A15NSFP-VB Datasheet N-Channel 100-V (D-S) MOSFET

PRODUCT	SUMMARY	
V _{(BR)DSS} (V)	$r_{DS(on)}(\Omega)$	I _D (A)
100	0.034 at V _{GS} = 10 V	50 ^a

FEATURES

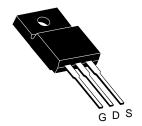
- Trench Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % R_g Tested

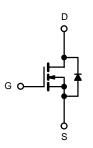


APPLICATIONS

• Isolated DC/DC Converters







NI	Chan	nall	MOSF	CT
IV-	unan	nerr	viuar	

ABSOLUTE MAXIMUM RATINGS	T _C = 25 °C, unless oth	erwise noted		
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	100	V
Gate-Source Voltage		V _{GS}	± 20	V
Continuous Drain Current (T _{.1} = 175 °C)	T _C = 25 °C	T _C = 25 °C	50 ^a	
Continuous Diam Current (1) = 173 C)	T _C = 125 °C	I _D	28 ^a	A
Pulsed Drain Current		I _{DM}	120	
Avalanche Current	L = 0.1 mH	I _{AS}	31	
Single Pulse Avalanche Energy ^b	L = 0.1 IIII1	E _{AS}	61	mJ
Mariana Barra Biraira di ah	T _C = 25 °C	В	360 ^c	10/
Maximum Power Dissipation ^b	T _A = 25 °C ^d	P _D	3.70	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATING	S			
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount (TO-263) ^d	R _{thJA}	40	°C/W
Junction-to-Case (Drain)		R _{thJC}	0.4	C/VV

Notes:

- a. Package limited.
- b. Duty cycle \leq 1 %.
- c. See SOA curve for voltage derating.
- d. When Mounted on 1" square PCB (FR-4 material).

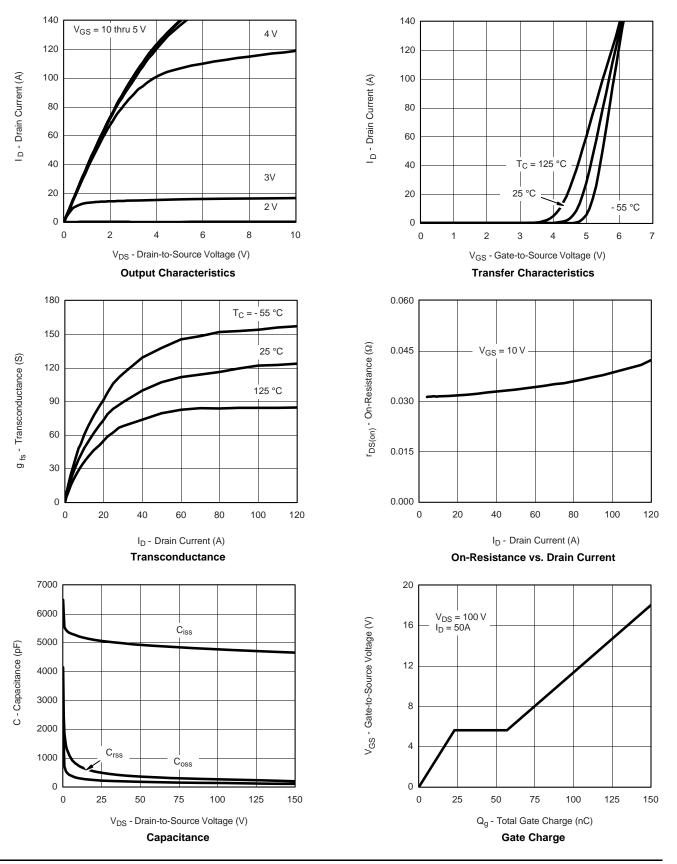


Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	100			V
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.5		2.5	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
		V _{DS} = 100 V, V _{GS} = 0 V			1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C			50	μΑ
		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 175 °C			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α
		V _{GS} = 10 V, I _D = 30 A		0.034		
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 30 A, T _J = 125 °C		0.063		Ω
		V _{GS} = 10 V, I _D = 30 A, T _J = 175 °C		0.084		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	25			S
Dynamic ^b	•			•		
Input Capacitance	C _{iss}			5100		
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		480		pF
Reverse Transfer Capacitance	C _{rss}			210		
Total Gate Charge ^c	Q_g			90	130	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 65 \text{ A}$		23		nC
Gate-Drain Charge ^c	Q_{gd}			34		
Gate Resistance	R_{g}		0.5	1.7	3.3	Ω
Turn-On Delay Time ^c	t _{d(on)}			24	35	
Rise Time ^c	t _r	$V_{DD} = 100 \text{ V}, R_{L} = 1.5 \Omega$		220	330	ns
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 65 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		45	70	
Fall Time ^c	t _f			200	300	
Source-Drain Diode Ratings and Ch	aracteristics 7	T _C = 25 °C ^b				
Continuous Current	I _S			50		۸
Pulsed Current	I _{SM}			120		Α
Forward Voltage ^a	V_{SD}	I _F = 65 A, V _{GS} = 0 V		1.0	1.5	V
Reverse Recovery Time	t _{rr}			130	200	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, di/dt = 100 A/μs		8	12	Α
Reverse Recovery Charge	Q _{rr}			0.52	1.2	μC

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing. c. Independent of operating temperature.

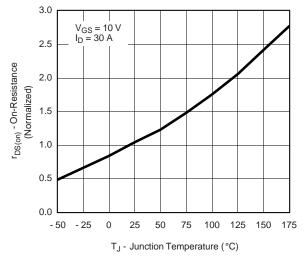


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

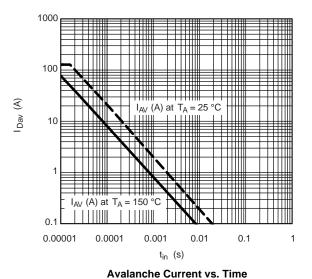




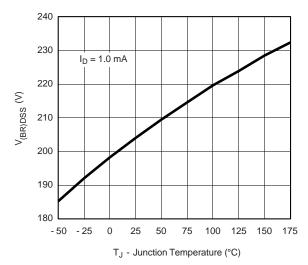
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage

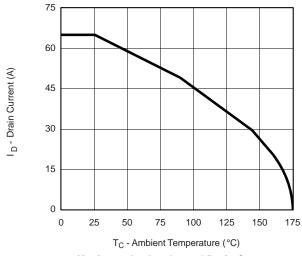


Drain Source Breakdown vs. Junction Temperature

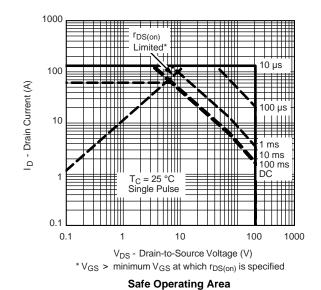


5

THERMAL RATINGS



Maximum Avalanche and Drain Current vs. Case Temperature



Duty Cycle = 0.5

O.2

O.2

O.05

Single Pulse

10-4

10-4

10-3

10-2

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

10-1

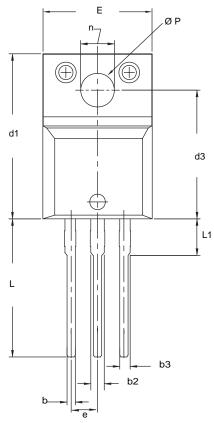
10-1

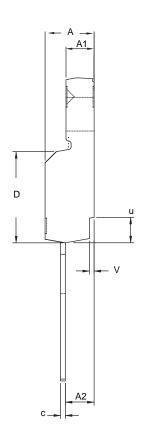
Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Case



TO-220 FULLPAK (HIGH VOLTAGE)





DIM.	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100	BSC	
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØΡ	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

ECN: X09-0126-Rev. B, 26-Oct-09 DWG: 5972

- To be used only for process drawing.
 These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads.
 All critical dimensions should C meet C_{pk} > 1.33.
- 4. All dimensions include burrs and plating thickness.
 5. No chipping or package damage.



Disclaimer

All products due to improve reliability, function or design or for other reasons, product specifications and data are subject to change without notice.

Taiwan VBsemi Electronics Co., Ltd., branches, agents, employees, and all persons acting on its or their representatives (collectively, the "Taiwan VBsemi"), assumes no responsibility for any errors, inaccuracies or incomplete data contained in the table or any other any disclosure of any information related to the product.(www.VBsemi.com)

Taiwan VBsemi makes no guarantee, representation or warranty on the product for any particular purpose of any goods or continuous production. To the maximum extent permitted by applicable law on Taiwan VBsemi relinquished: (1) any application and all liability arising out of or use of any products; (2) any and all liability, including but not limited to special, consequential damages or incidental; (3) any and all implied warranties, including a particular purpose, non-infringement and merchantability guarantee.

Statement on certain types of applications are based on knowledge of the product is often used in a typical application of the general product VBsemi Taiwan demand that the Taiwan VBsemi of. Statement on whether the product is suitable for a particular application is non-binding. It is the customer's responsibility to verify specific product features in the products described in the specification is appropriate for use in a particular application. Parameter data sheets and technical specifications can be provided may vary depending on the application and performance over time. All operating parameters, including typical parameters must be made by customer's technical experts validated for each customer application. Product specifications do not expand or modify Taiwan VBsemi purchasing terms and conditions, including but not limited to warranty herein.

Unless expressly stated in writing, Taiwan VBsemi products are not intended for use in medical, life saving, or life sustaining applications or any other application. Wherein VBsemi product failure could lead to personal injury or death, use or sale of products used in Taiwan VBsemi such applications using client did not express their own risk. Contact your authorized Taiwan VBsemi people who are related to product design applications and other terms and conditions in writing.

The information provided in this document and the company's products without a license, express or implied, by estoppel or otherwise, to any intellectual property rights granted to the VBsemi act or document. Product names and trademarks referred to herein are trademarks of their respective representatives will be all.

Material Category Policy

Taiwan VBsemi Electronics Co., Ltd., hereby certify that all of the products are determined to be RoHS compliant and meets the definition of restrictions under Directive of the European Parliament 2011/65 / EU, 2011 Nian. 6. 8 Ri Yue restrict the use of certain hazardous substances in electrical and electronic equipment (EEE) - modification, unless otherwise specified as inconsistent.(www.VBsemi.com)

Please note that some documents may still refer to Taiwan VBsemi RoHS Directive 2002/95 / EC. We confirm that all products identified as consistent with the Directive 2002/95 / EC European Directive 2011/65 /.

Taiwan VBsemi Electronics Co., Ltd. hereby certify that all of its products comply identified as halogen-free halogen-free standards required by the JEDEC JS709A. Please note that some Taiwanese VBsemi documents still refer to the definition of IEC 61249-2-21, and we are sure that all products conform to confirm compliance with IEC 61249-2-21 standard level JS709A.